

**SURFACE MOUNT
GLASS PASSIVATED BRIDGE RECTIFIERS**

REVERSE VOLTAGE - 100 to 1000 Volts
FORWARD CURRENT - 0.8 Amperes

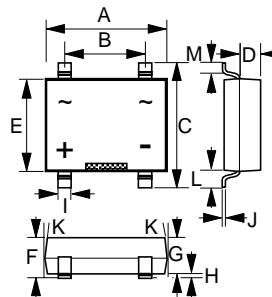
FEATURES

- Rating to 1000V PRV
- Ideal for printed circuit board
- Reliable low cost construction utilizing molded plastic technique results in inexpensive product
- Lead tin plated copper
- The plastic material has UL recognition File # E95060

MECHANICAL DATA

- Polarity : Symbol molded on body
- Weight : 0.0044 ounces, 0.125 grams
- Mounting position : Any

HDDF



HDDF		
DIM.	MIN.	MAX.
A	4.50	4.90
B	2.30	2.70
C	—	7.00
D	1.20	1.60
E	3.60	4.00
F	—	3.00
G	2.30	2.70
H	—	0.20
I	0.50	0.80
J	0.15	0.35
K	5° TYPICAL	
L	1.30	1.70
M	0.70	1.10

All Dimensions in millimeter

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Ratings at 25°C ambient temperature unless otherwise specified.
Single phase, half wave, 60Hz, resistive or inductive load.
For capacitive load, derate current by 20%

CHARACTERISTICS	SYMBOL	HD01	HD02	HD04	HD06	HD08	HD10	UNIT
Maximum Recurrent Peak Reverse Voltage	VRRM	100	200	400	600	800	1000	V
Maximum RMS Voltage	VRMS	70	140	280	420	560	700	V
Maximum DC Blocking Voltage	VDC	100	200	400	600	800	1000	V
Maximum Average Forward Rectified Current (Note 1) @TA=40 °C	I(AV)	0.8						A
Peak Forward Surge Current 8.3ms single half sine-wave superimposed on rated load (JEDEC METHOD)	IFSM	30						A
Maximum Forward Voltage at 0.4A DC	VF	5						V
Maximum DC Reverse Current @TJ=25 °C at Rated DC Blocking Voltage @TJ=125 °C	IR	5 500						uA
I ² t Rating for fusing (t < 8.3ms)	I ² t	3.7						A ² S
Typical Junction Capacitance per element (Note 2)	CJ	15						pF
Typical Thermal Resistance (Note 3)	RθJA	75						°C/W
Operating Temperature Range	TJ	-55 to + 150						°C
Storage Temperature Range	TSTG	-55 to + 150						°C

NOTES : 1. Mounted on P.C. board.
2. Measured at 1.0MHz and applied reverse voltage of 4.0V DC.
3. Thermal Resistance Junction to Ambient.

